

N-Channel Enhancement Mode Power MOSFET

<p>Description</p> <p>The G60KN30I uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge. It can be used in a wide variety of applications.</p> <p>General Features</p> <ul style="list-style-type: none"> ● V_{DS} 300V ● I_D (at $V_{GS} = 10V$) 0.3A ● $R_{DS(ON)}$ (at $V_{GS} = 10V$) < 5.4Ω ● 100% Avalanche Tested ● RoHS Compliant <p>Application</p> <ul style="list-style-type: none"> ● Power switch ● DC/DC converters 	<p>Schematic diagram</p> <p>SOT-23</p>
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Ordering Information			
Device	Package	Marking	Packaging
G60KN30I	SOT-23	G60KN30	3000pcs/Reel

Absolute Maximum Ratings $T_C = 25^\circ\text{C}$, unless otherwise noted			
Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	300	V
Continuous Drain Current	I_D	0.3	A
Pulsed Drain Current (note1)	I_{DM}	1.2	A
Gate-Source Voltage	V_{GS}	± 30	V
Power Dissipation	P_D	0.71	W
Operating Junction and Storage Temperature Range	T_J, T_{stg}	-55 To 150	°C

Thermal Resistance			
Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-Ambient, $t \leq 10s$	R_{thJA}	175	°C/W

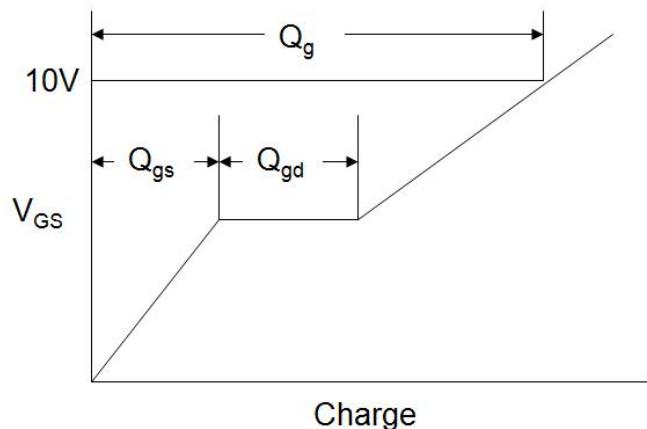
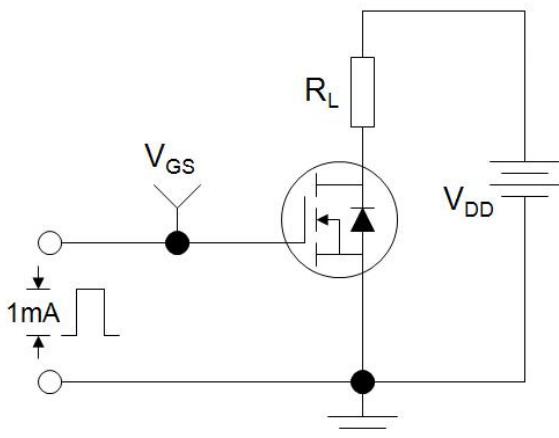
Specifications $T_J = 25^\circ\text{C}$, unless otherwise noted

Parameter	Symbol	Test Conditions	Value			Unit
			Min.	Typ.	Max.	
Static Parameters						
Drain-Source Breakdown Voltage	$V_{(\text{BR})\text{DSS}}$	$V_{\text{GS}} = 0\text{V}, I_D = 250\mu\text{A}$	300	--	--	V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{\text{DS}} = 300\text{V}, V_{\text{GS}} = 0\text{V}$	--	--	1	μA
Gate-Source Leakage	I_{GSS}	$V_{\text{GS}} = \pm 30\text{V}$	--	--	± 100	nA
Gate-Source Threshold Voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{DS}} = V_{\text{GS}}, I_D = 250\mu\text{A}$	2.0	3.0	4.0	V
Drain-Source On-Resistance	$R_{\text{DS}(\text{on})}$	$V_{\text{GS}} = 10\text{V}, I_D = 0.3\text{A}$	--	4.2	5.4	Ω
Forward Transconductance	g_{FS}	$V_{\text{GS}} = 5\text{V}, I_D = 0.3\text{A}$	--	0.15	--	S
Dynamic Parameters						
Input Capacitance	C_{iss}	$V_{\text{GS}} = 0\text{V}, V_{\text{DS}} = 150\text{V}, f = 1.0\text{MHz}$	--	68	--	pF
Output Capacitance	C_{oss}		--	11	--	
Reverse Transfer Capacitance	C_{rss}		--	3	--	
Total Gate Charge	Q_g	$V_{\text{DD}} = 150\text{V}, I_D = 0.3\text{A}, V_{\text{GS}} = 10\text{V}$	--	2.5	--	nC
Gate-Source Charge	Q_{gs}		--	0.2	--	
Gate-Drain Charge	Q_{gd}		--	1	--	
Turn-on Delay Time	$t_{\text{d}(\text{on})}$	$V_{\text{DD}} = 150\text{V}, I_D = 0.3\text{A}, R_G = 6\Omega$	--	4	--	ns
Turn-on Rise Time	t_r		--	3.6	--	
Turn-off Delay Time	$t_{\text{d}(\text{off})}$		--	16	--	
Turn-off Fall Time	t_f		--	76	--	
Drain-Source Body Diode Characteristics						
Continuous Body Diode Current	I_s	$T_C = 25^\circ\text{C}$	--	--	0.3	A
Body Diode Voltage	V_{SD}	$T_J = 25^\circ\text{C}, I_{\text{SD}} = 0.3\text{A}, V_{\text{GS}} = 0\text{V}$	--	--	1.2	V
Reverse Recovery Charge	Q_{rr}	$I_F = 0.3\text{A}, V_{\text{GS}} = 0\text{V}$ $di/dt = 100\text{A}/\mu\text{s}$	--	27	--	nC
Reverse Recovery Time	T_{rr}		--	51	--	ns

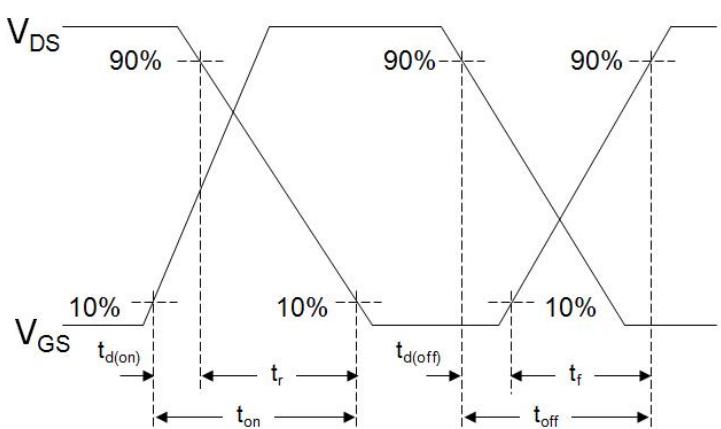
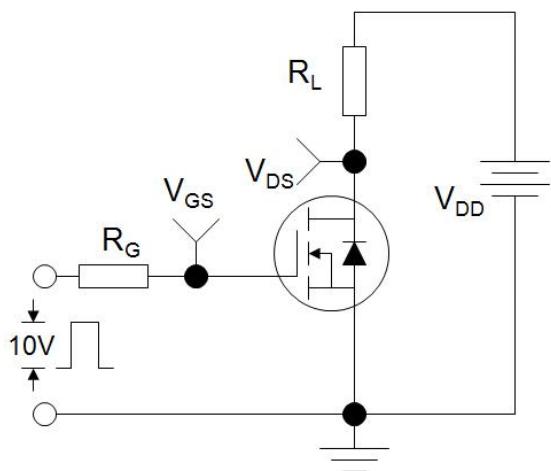
Notes

1. Repetitive Rating: Pulse width limited by maximum junction temperature
2. Identical low side and high side switch with identical R_G

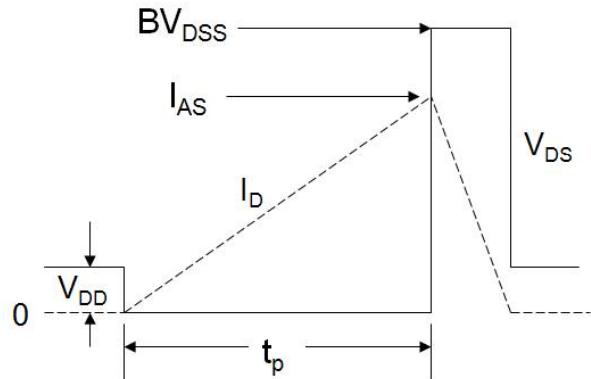
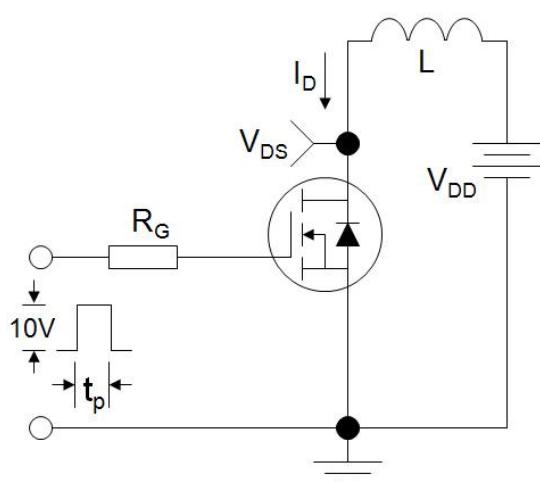
Gate Charge Test Circuit



Switch Time Test Circuit



EAS Test Circuit



Typical Characteristics $T_J = 25^\circ\text{C}$, unless otherwise noted

Figure 1. Output Characteristics

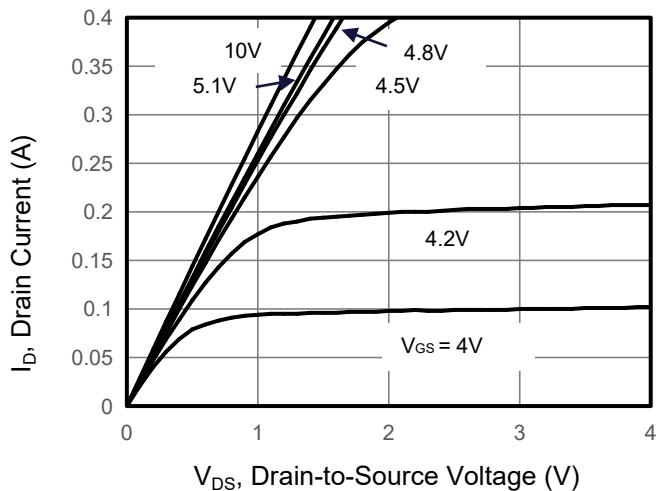


Figure 2. Transfer Characteristics

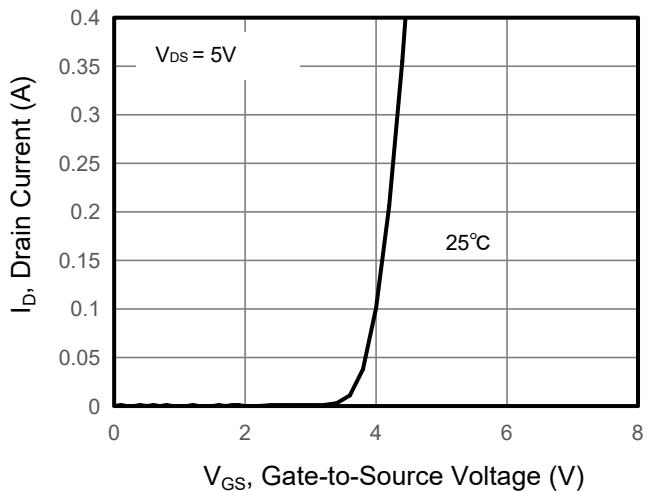


Figure 3. Drain Source On Resistance

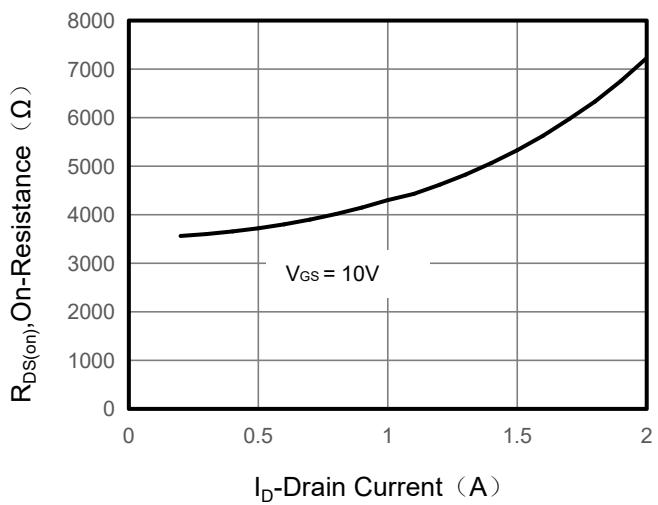


Figure 4. Gate Charge

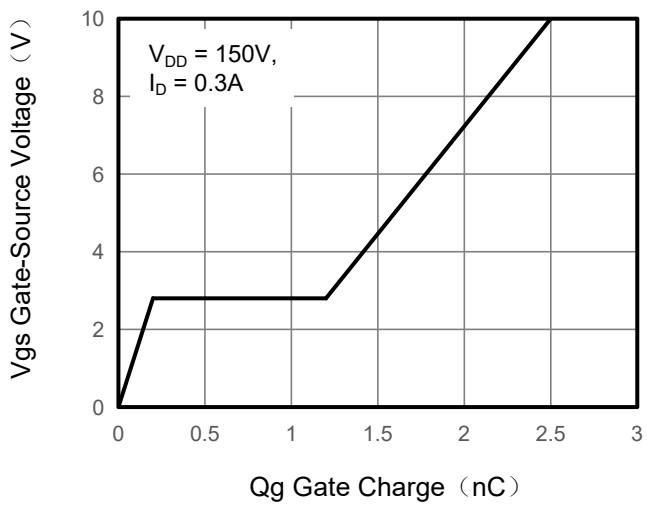


Figure 5. Capacitance

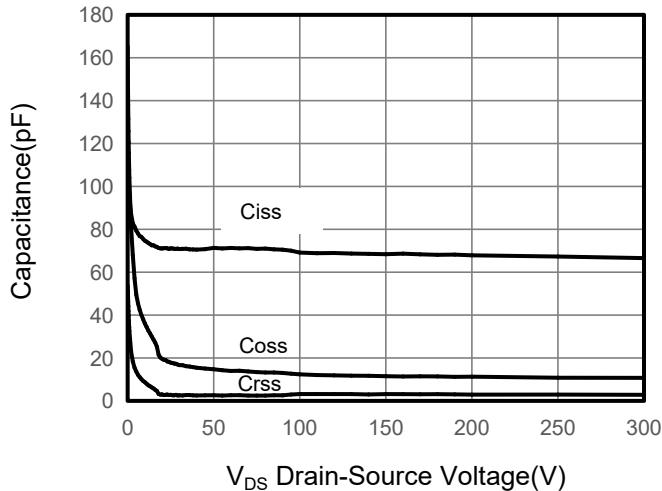
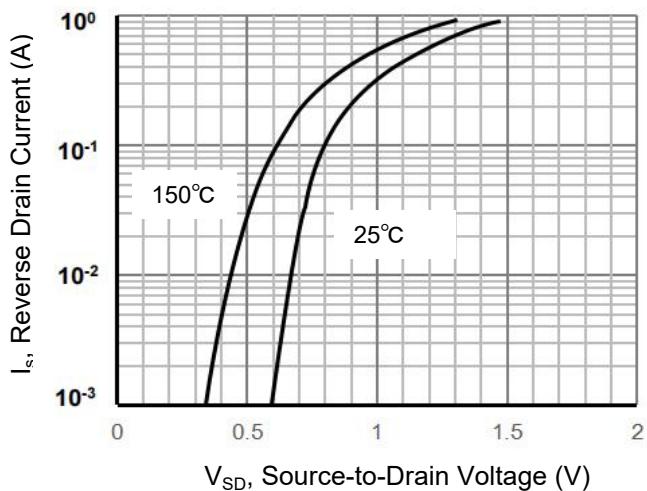


Figure 6. Source-Drain Diode Forward



Typical Characteristics $T_J = 25^\circ\text{C}$, unless otherwise noted

Figure 7. Drain-Source On-Resistance

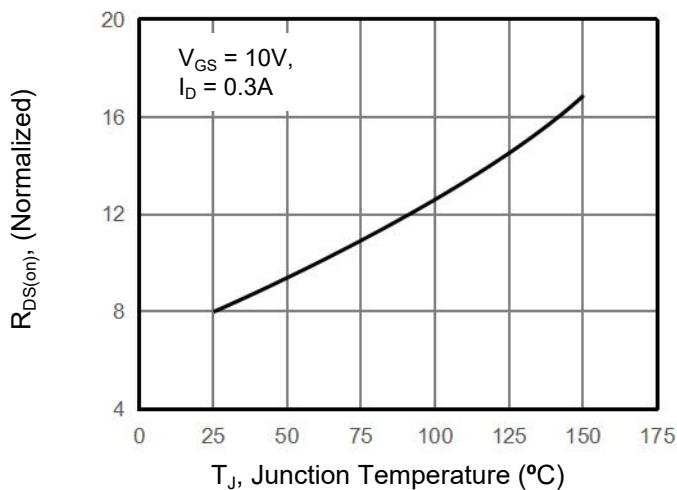


Figure 8. Safe Operation Area

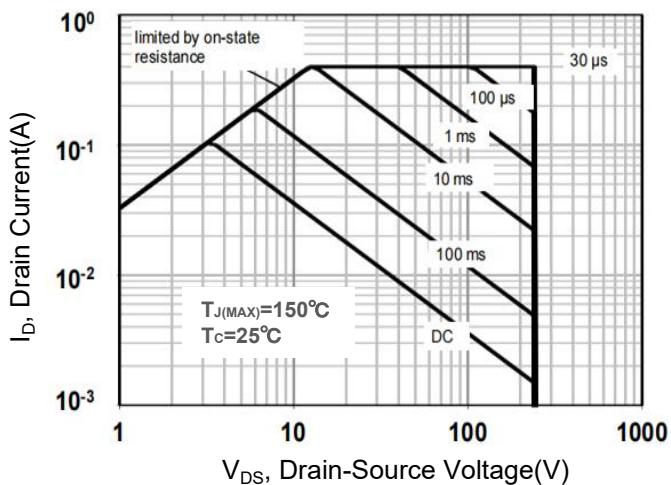
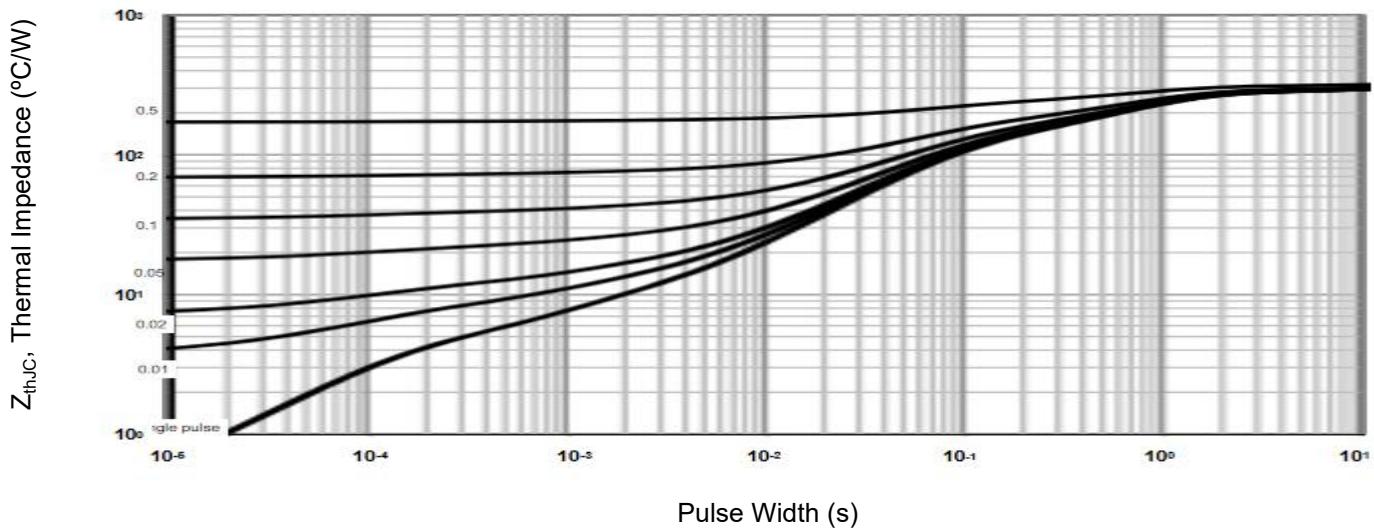
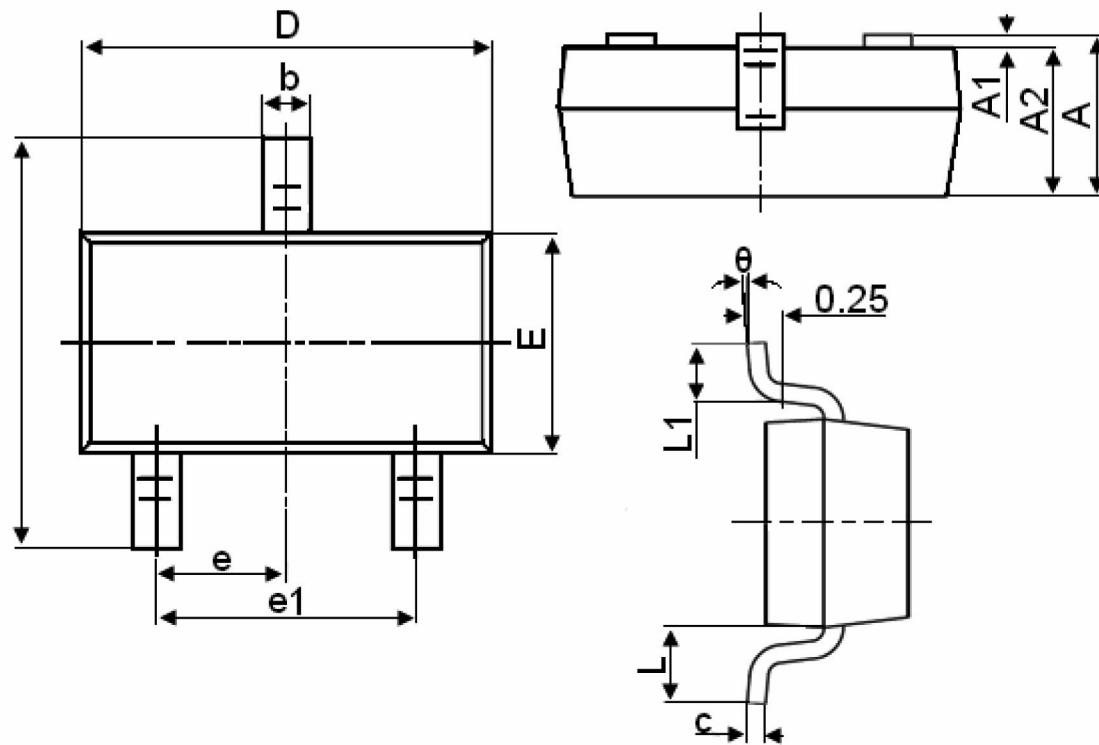


Figure 9. Normalized Maximum Transient Thermal Impedance



SOT-23 Package Information

Symbol	Dimensions in Millimeters	
	MIN.	MAX.
A	0.900	1.150
A1	0.000	0.100
A2	0.900	1.050
b	0.300	0.500
c	0.080	0.150
D	2.800	3.000
E	1.200	1.400
E1	2.250	2.550
e	0.950TYP	
e1	1.800	2.000
L	0.550REF	
L1	0.300	0.500
θ	0°	8°

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